

Descriptions

This is 650V 30A Trench FS Technology IGBT in a TO-247 Plastic Package.

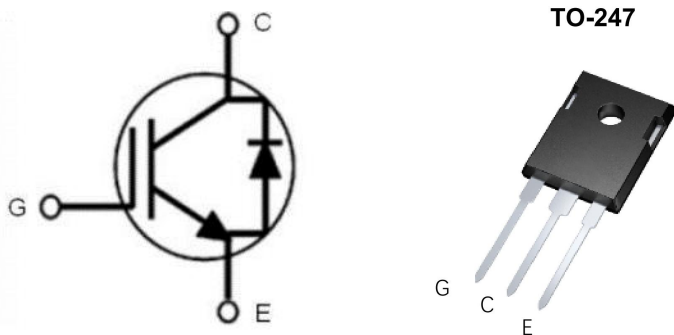
Features

- High ruggedness performance
- 10 μ s short circuit capability
- Positive VCE(sat) temperature coefficient
- High efficiency for motor control
- Excellent current sharing in parallel operation
- RoHS compliant

Applications

- Motor Drives
- Home Appliance Applications
- General inverter

Equivalent Circuit & Pinning



Marking

See Marking Instructions

Maximum Ratings

Parameter	Symbol	Test Condition	Values	Unit
Collector to Emitter Voltage	V_{CES}		650	V
Gate to Emitter Voltage	V_{GES}		± 20	V
Collector Current	I_C	$T_C=25^\circ\text{C}$	60	A
		$T_C=100^\circ\text{C}$	30	
Pulsed Collector Current	I_{CM}	Pulse width limited by T_{Jmax}	120	A
Diode Continuous Forward Current	I_F	$T_C=100^\circ\text{C}$	30	A
Maximum Power Dissipation	P_D	$T_C=25^\circ\text{C}$	187	W
		$T_C=100^\circ\text{C}$	93	
Operating Junction Temperature Range	T_J		-40~+175	$^\circ\text{C}$
Storage Temperature Range	T_{STG}		-55~+150	$^\circ\text{C}$
Thermal Resistance, Junction to case for IGBT	$R_{th(J-C)}$		0.8	$^\circ\text{C/W}$
Thermal Resistance, Junction to case for Diode	$R_{th(J-C)}$		1.8	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient	$R_{th(J-A)}$		40	$^\circ\text{C/W}$

Electrical Characteristics of IGBT

Parameter	Symbol	Test Condition		Min.	Typ.	Max.	Unit	
Collector to Emitter Breakdown Voltage	BV_{CES}	$I_C=250\mu A, V_{GE}=0V$	$T_J=25^\circ C$	650	-	-	V	
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=30A, V_{GE}=15V$	$T_J=25^\circ C$	-	1.7	-	V	
Gate Threshold Voltage	$V_{GE(th)}$	$I_C=1mA, V_{GE}=V_{CE}$	$T_J=25^\circ C$	5.3	5.7	5.9	V	
Zero Gate Voltage Collector current	I_{CES}	$V_{CE}=650V, V_{GS}=0V$	$T_J=25^\circ C$	-	-	50	μA	
Gate to Emitter Leakage Current	I_{GES}	$V_{GE}=\pm 20V, V_{CE}=0V$	$T_J=25^\circ C$	-	-	± 100	nA	
Input Capacitance	C_{ies}	$f=1MHz, V_{CE}=25V, V_{GE}=0V$	$T_J=25^\circ C$	-	1978	-	pF	
Output Capacitance	C_{oes}			-	100	-		
Reverse Transfer Capacitance	C_{res}			-	23	-		
Total Gate Charge	Q_g	$V_{CC}=520V, I_C=30A, V_{GE}=15V$	$T_J=25^\circ C$	-	103	-	nc	
Short Circuit Withstand Time	t_{SC}	$V_{CC}=400V, V_{GE}=15V$	$T_J=25^\circ C$	10	-	-	μs	
Turn-on Delay Time	$t_{d(on)}$	$V_{CC}=400V, I_C=30A, V_{GE}=0/15V, R_G=10\Omega, \text{ Inductive load}$	$T_J=25^\circ C$	-	30	-	n	
Rising Time	t_r		$T_J=25^\circ C$	-	39	-	s	
Turn-off Delay Time	$t_{d(off)}$		$T_J=25^\circ C$	-	151	-	n	
Falling Time	t_f		$T_J=25^\circ C$	-	29	-	ns	
Turn-on Switching Loss	E_{on}		$T_J=25^\circ C$	-	0.95	-	mJ	
Turn-off Switching Loss	E_{off}		$T_J=25^\circ C$	-	0.60	-	mJ	
Total Switching Energy	E_{total}		$T_J=25^\circ C$	-	1.55	-	mJ	
Turn-on Delay Time	$t_{d(on)}$		$V_{CC}=400V, I_C=30A, V_{GE}=0/15V, R_G=10\Omega, \text{ Inductive load}$	$T_J=175^\circ C$	-	28	-	ns
Rising Time	t_r			$T_J=175^\circ C$	-	40	-	ns
Turn-off Delay Time	$t_{d(off)}$			$T_J=175^\circ C$	-	169	-	ns
Falling Time	t_f	$T_J=175^\circ C$		-	71	-	ns	
Turn-on Switching Loss	E_{on}	$T_J=175^\circ C$		-	1.5	-	mJ	
Turn-off Switching Loss	E_{off}	$T_J=175^\circ C$		-	0.8	-	mJ	
Total Switching Energy	E_{total}	$T_J=175^\circ C$		-	2.3	-	mJ	

Electrical Characteristics of Diode

Parameter	Symbol	Test Condition		Min.	Typ.	Max.	Unit
Diode Forward Voltage	V _F	I _F =30A	T _J =25°C	-	1.4	-	V
			T _J =175°C	-	1.2	-	
Diode Peak Reverse Recovery Current	I _{RM}		T _J =25°C	-	16	-	A
			T _J =175°C	-	26	-	
Diode Reverse Recovery Time	t _{rr}	I _F =30A di/dt=- 550A/μs V _{CC} =400V	T _J =25°C	-	105	-	ns
			T _J =175°C	-	171	-	
Diode Reverse Recovery Charge	Q _{rr}		T _J =25°C	-	876	-	nC
			T _J =175°C	-	2650	-	

Typical Performance

Fig.1 Typical output characteristic($T_{vj}=25^{\circ}\text{C}$)

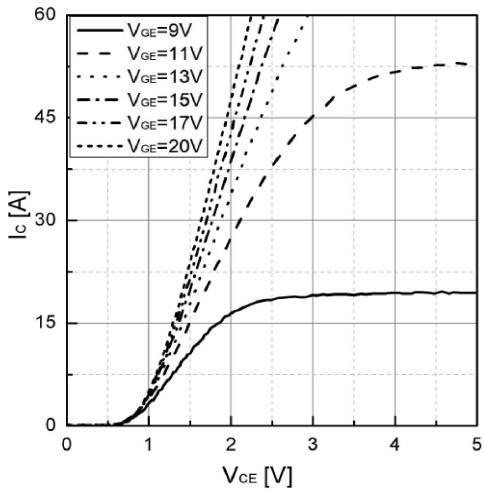


Fig.2 Typical output characteristic($T_{vj}=175^{\circ}\text{C}$)

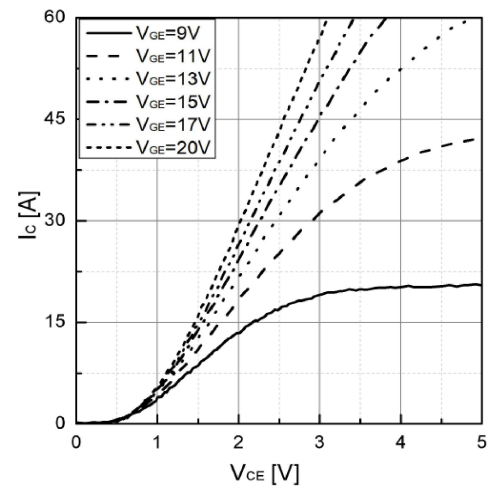


Fig.3 Power dissipation as a function of T_c

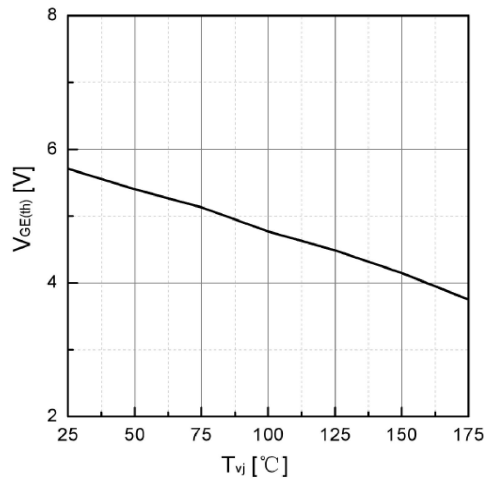


Fig.4 Typical Gate charge

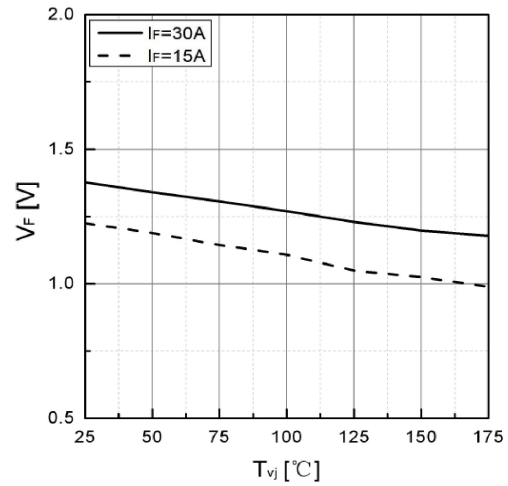


Fig.5 Typical $V_{GE(th)}$ as a function of T_{vj} ($I_c=1\text{mA}$)

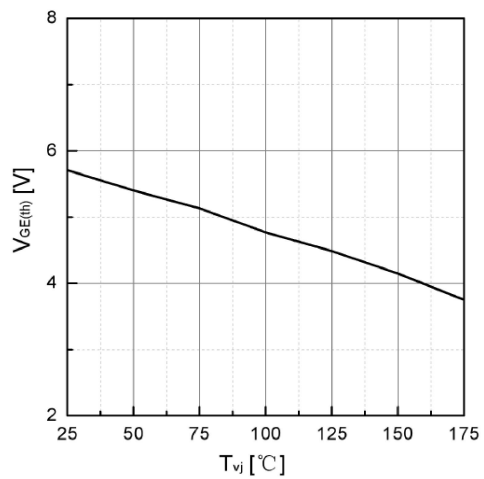
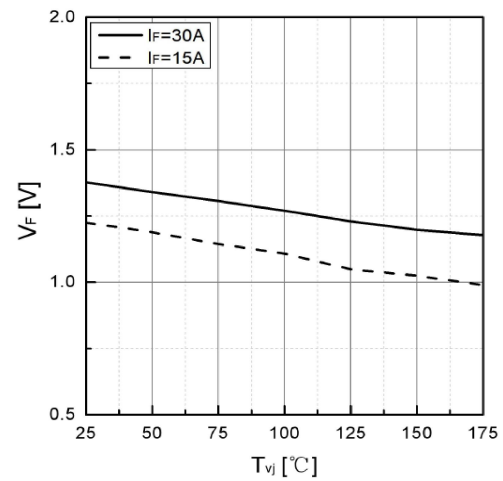


Fig.6 Typical V_f as a function of T_{vj}



Typical Performance

Fig.7 Typical V_{CEsat} as a function of T_{vj}

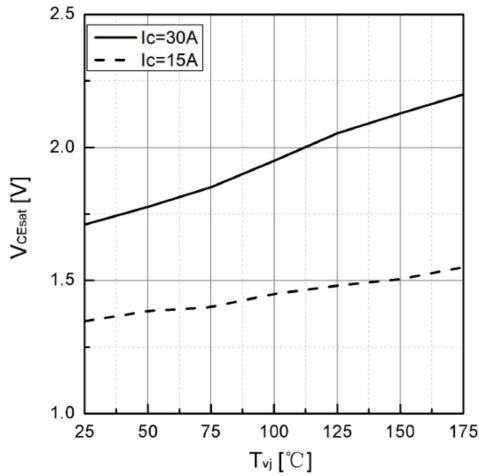


Fig.8 Typical I_F as a function of V_F

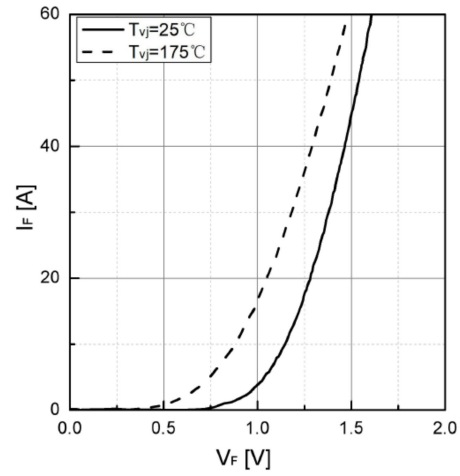


Fig.9 Typical switching time as a function of I_c

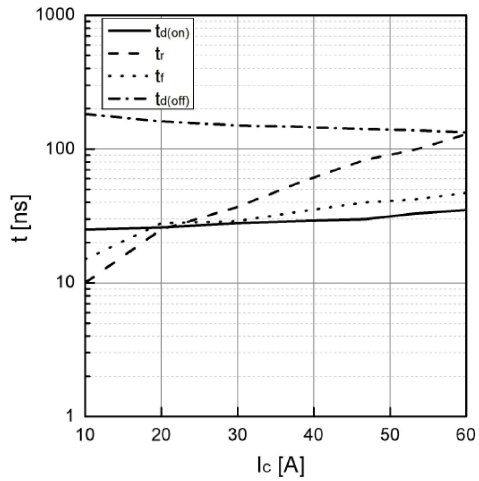


Fig.10 Typical switching times as a function of R_G

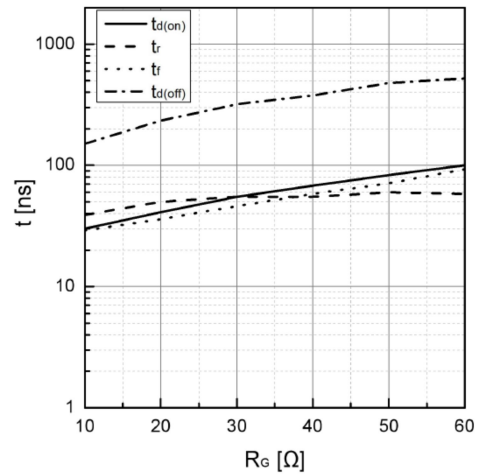


Fig 11 Typical switching energy losses as a function of I_c

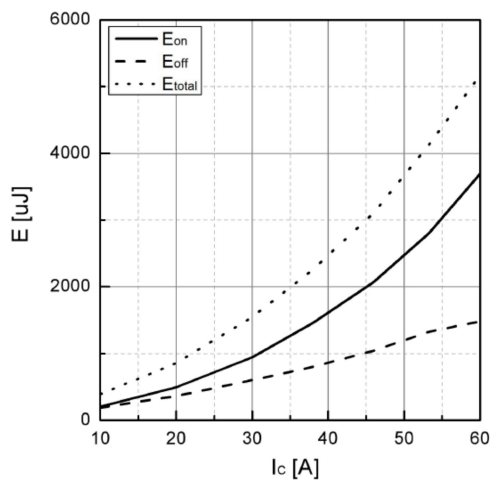
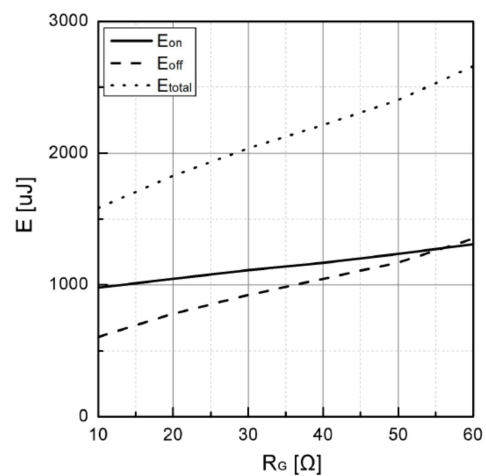


Fig 12 Typical switching energy losses as a function of R_G



Typical Performance

Fig.13 Switching Time vs. R_g
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=6\text{A}$)

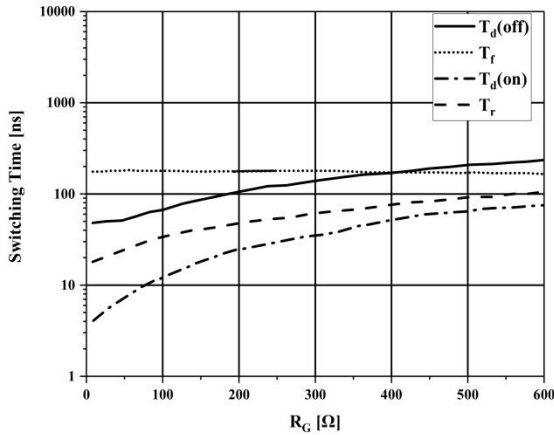


Fig.14 Switching Time vs. Junction Temperature
($V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=6\text{A}, R_g=60\Omega$)

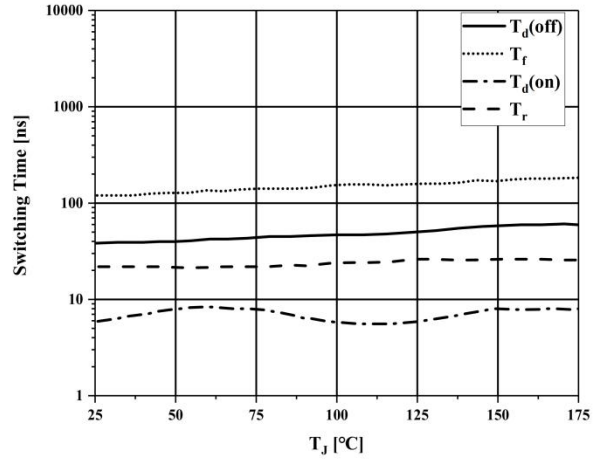


Fig.15 V_{GEth} vs. Junction Temperature

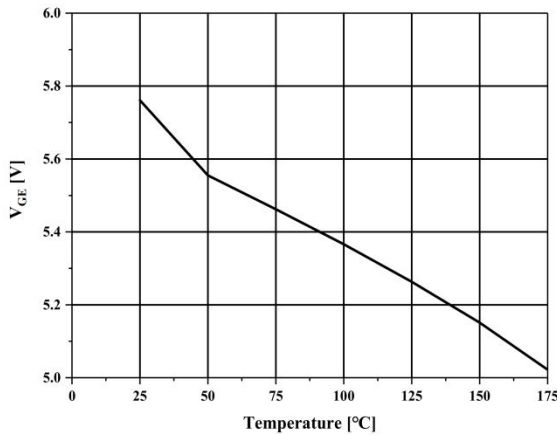


Fig.16 Switching Loss vs. I_C

($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=60\Omega$)

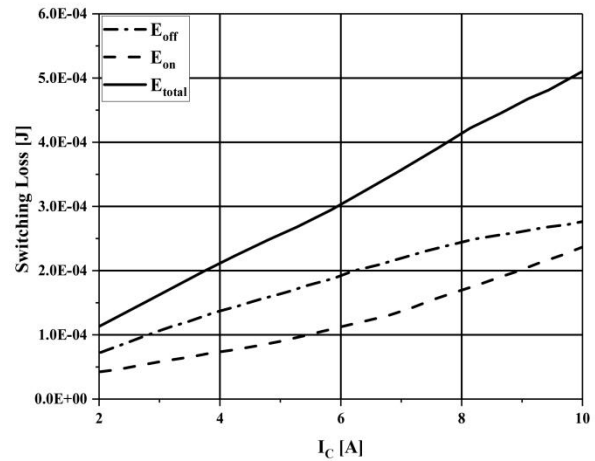


Fig.17 Switching Loss vs. R_g
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=6\text{A}$)

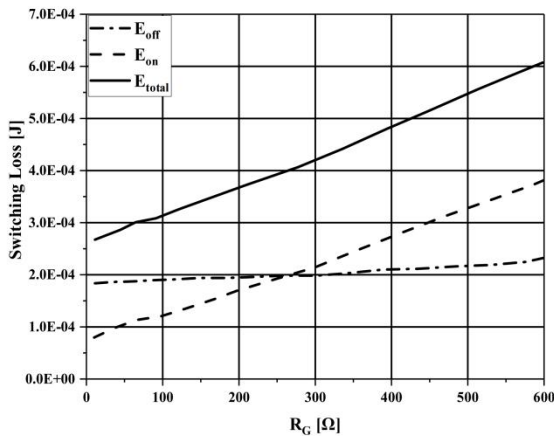
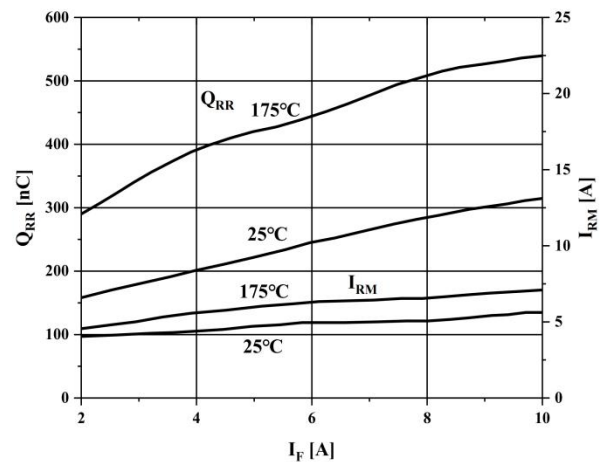
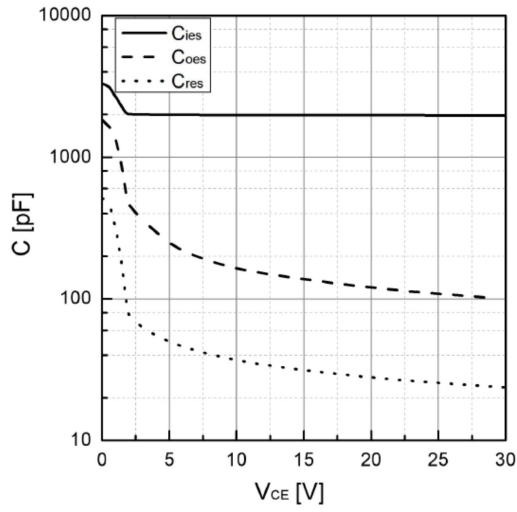


Fig.18 Diode Reverse Recovery Charge and Peak Current vs. Conduction Forward Current
($V_{GE}=15\text{V}, V_{CE}=400\text{V}, di/dt=200\text{A}/\mu\text{s}$)



Typical Performance

Fig 13 Typical capacitance as a function of V_C ($f=1\text{MHz}$, $V_{GE}=0\text{V}$)



Marking Information

Note:

COT: Company

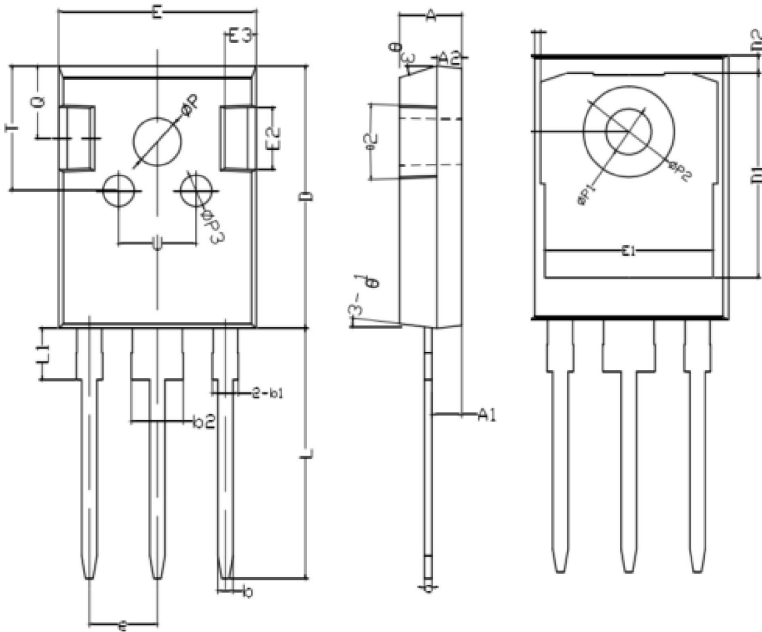
GB30N65: Product Type.

*****: *: Inner Code * : Year Code **: Week Code **: Lot Code

Ordering Information

Part	Package	Marking	Packing method
CTGB30N65SHA	TO-247-3	30N65	Tube

Mechanical Dimensions for TO-247



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	4.80	5.20
A1	2.21	2.59
A2	1.85	2.15
b	1.11	1.36
b1	1.91	2.25
b2	2.91	3.25
c	0.51	0.75
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.00	13.60
E2	4.80	5.20
E3	2.30	2.70
e	5.40	5.48
L	19.62	20.22
L1	-	4.30
ØP	3.40	3.80
ØP2	6.90	7.30
S	6.05	6.25